



B360AM

3.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(MAX)} @ +25°C (V)	I _{R(MAX)} @ V _{RRM} (mA)
60	3.0	0.70	0.10

Features

- Guard Ring Die Construction for Transient Protection
- Low Leakage at High Temperature
- Low Power Loss, High Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

B360AM is a very low leakage version of B360A. For use in low voltage, high frequency inverters, freewheeling, DC-DC converters, and polarity protection applications.

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. "Green" Molding compound.
 UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Polarity: Cathode Band
- Weight: 0.064 grams (Approximate)

SMA







Bottom View

Ordering Information (Note 4)

Part Number*	Compliance	Case	Packaging
B360AM-13-F	Standard	SMA	5,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SMA





Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	\ \
Average Rectified Output Current @ $T_T = +1$	00°C I _O	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		80	Α

Thermal Characteristics

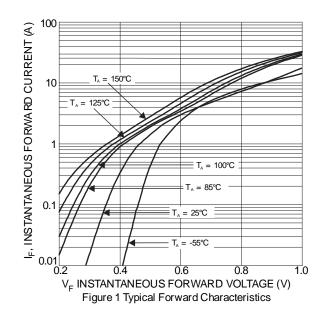
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	100	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	$R_{\theta JL}$	30	°C/W
Operating Temperature Range	T_J	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

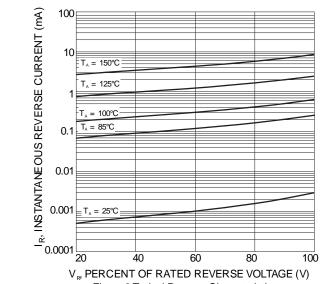
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	\/-		0.60	0.70		$I_F = 3.0A, T_A = +25^{\circ}C$
Forward Voltage Drop	V _F		0.54	_		I _F = 3.0A, T _A = +125°C
Leakage Current (Note 6)		_	0.003	0.10	mA	$V_R = 60V, T_A = +25^{\circ}C$
		_	2.4	_		V _R = 60V, T _A = +125°C
Total Capacitance		_	130	_	pF	$V_R = 4V$, $f = 1MHz$

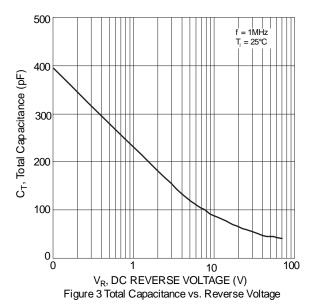
Notes:

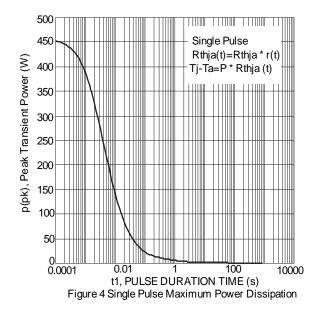
- 5. Device mounted on FR-4 PCB, 1* 1 sq. inch, 2 oz Cu single-side with 0.1 * 0.15 sq. inch copper pad.
- 6. Short duration pulse test used to minimize self-heating effect.

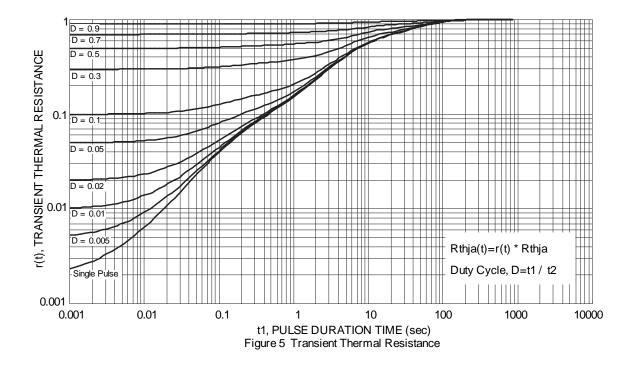








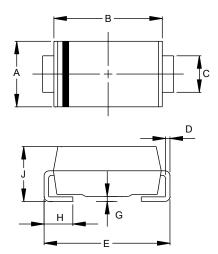






Package Outline Dimensions

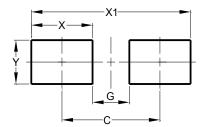
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
Е	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Υ	1 70



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